## PRODUCT CHANGE NOTICE

**PART NUMBER(S):**

Please see attachment.

**PCN No.:** 06-0130-13a

**DATE:** June 23, 2006

**PART DESCRIPTION:**

Power Management and Interface Products – Change in Wafer Fabrication Site

**LEVEL OF CHANGE:**

[X] Level I, Customer Approval.  [ ] Level II, Customer Information.

**PRODUCT ATTRIBUTE AFFECTED:**

[ ] Material Change

[ ] Design Change

[X] Process Change

[ ] Data Sheet Change

[ ] Package Change

[ ] Packing / Shipping

[X] Other, Explain: Wafer Fabrication Site Transfer

**DESCRIPTION OF CHANGE:**

Announcing transfer of certain Power Management and Interface Products from Hillview wafer fabrication facility to wafer foundry EPISIL. See attached Product List no. 13.

**REASON FOR CHANGE:**

Power Management and Interface products as listed are being transferred to external wafer foundry, due to cessation of operations of the Sipex Hillview Wafer Fabrication manufacturing site.

**FABRICATION PROCESS QUALIFICATION COMPLETED (DATE):** November 22, 2006

**PRODUCT CHARACTERIZATION COMPLETED AND SAMPLES* AVAILABLE (DATE):** November 29, 2006

* Samples representative of product from the Product Family being transferred.
**PRODUCT CHANGE NOTICE**

**EARLIEST DATE OF PRODUCTION SHIPMENTS:** January 31, 2007

**EFFECTIVITY CHANGE DATE OR DATE CODE:** Work week associated with earliest production shipment.

| [ ] STANDARD DISTRIBUTION | [ X ] CUSTOM DISTRIBUTION |

**PERSON TO CONTACT WITH QUESTIONS:**

Fred Claussen  
VP Quality Assurance and Reliability  
Sipex Corporation  
Phone Number: 408-935-7644  
FAX NUMBER: 408-935-7678
PRODUCT CHANGE NOTICE

PCN No.: 06-0130-13

List 13

SP485RCN
SP485RCN-L
SP485RCP
SP485RCP-L
SP485RCS-L
SP485REN
SP485REN-L
SP485REP
SP485REP-L
SP485RES-L